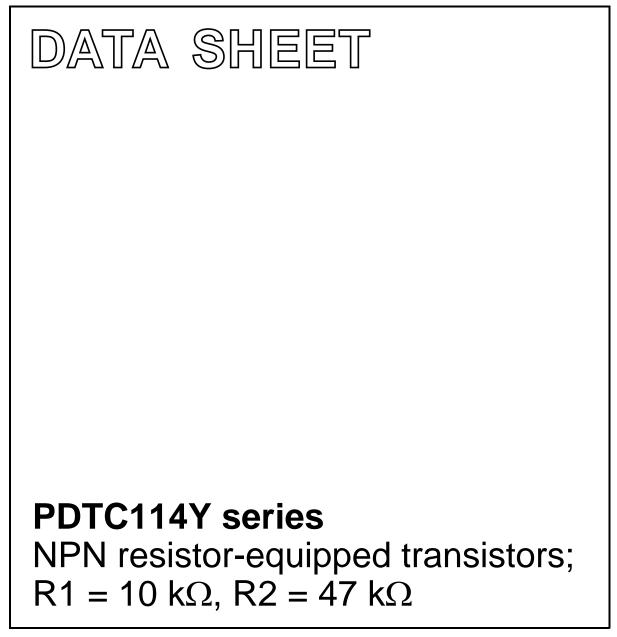
DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 2003 Sep 10



PDTC114Y series

FEATURES

- Built-in bias resistors
- Simplified circuit design
- Reduction of component count
- Reduced pick and place costs.

APPLICATIONS

- General purpose switching and amplification
- · Inverter and interface circuits
- Circuit driver.

PRODUCT OVERVIEW

QUICK REFERENCE DATA

| SYMBOL | PARAMETER | TYP. | MAX. | UNIT | |
|------------------|-----------------------------|------|------|------|--|
| V _{CEO} | collector-emitter – voltage | | 50 | V | |
| lo | output current (DC) | - | 100 | mA | |
| R1 | bias resistor | 10 | - | kΩ | |
| R2 | bias resistor | 47 | - | kΩ | |

DESCRIPTION

NPN resistor-equipped transistor (see "Simplified outline, symbol and pinning" for package details).

| TYPE NUMBER | PACKAGE | | MARKING CODE | PNP COMPLEMENT | |
|-------------|---------------|--------|--------------------|----------------|--|
| ITPE NOWBER | PHILIPS EIAJ | | MARKING CODE | | |
| PDTC114YE | SOT416 | SC-75 | 33 | PDTA114YE | |
| PDTC114YEF | SOT490 | SC-89 | 12 | PDTA114YEF | |
| PDTC114YK | SOT346 | SC-59 | 47 | PDTA114YK | |
| PDTC114YM | SOT883 | SC-101 | DU | PDTA114YM | |
| PDTC114YS | SOT54 (TO-92) | SC-43 | TC114Y | PDTA114YS | |
| PDTC114YT | SOT23 | - | *27 ⁽¹⁾ | PDTA114YT | |
| PDTC114YU | SOT323 | SC-70 | *30 ⁽¹⁾ | PDTA114YU | |

Note

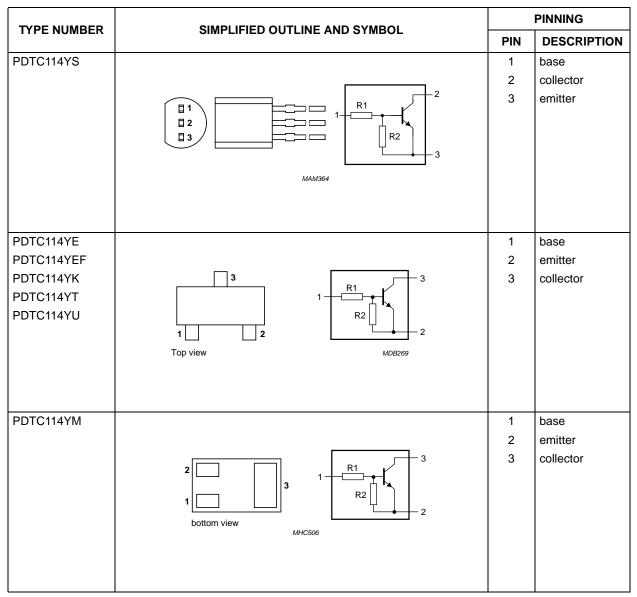
1. * = p: Made in Hong Kong.

* = t: Made in Malaysia.

* = W: Made in China.

PDTC114Y series

SIMPLIFIED OUTLINE, SYMBOL AND PINNING



PDTC114Y series

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------|------------------------------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | - | 50 | V |
| V _{CEO} | collector-emitter voltage | open base | - | 50 | V |
| V _{EBO} | emitter-base voltage | open collector | - | 10 | V |
| VI | input voltage | | | | |
| | positive | | — | +40 | V |
| | negative | | — | -6 | V |
| I _O | output current (DC) | | - | 100 | mA |
| I _{CM} | peak collector current | | - | 100 | mA |
| P _{tot} | total power dissipation | $T_{amb} \le 25 \ ^{\circ}C$ | | | |
| | SOT54 | note 1 | — | 500 | mW |
| | SOT23 | note 1 | - | 250 | mW |
| | SOT346 | note 1 | - | 250 | mW |
| | SOT323 | note 1 | - | 200 | mW |
| | SOT416 | note 1 | - | 150 | mW |
| | SOT883 | notes 2 and 3 | - | 250 | mW |
| | SOT490 | notes 1 and 2 | - | 250 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | - | 150 | °C |
| T _{amb} | operating ambient temperature | | -65 | +150 | °C |

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μ m copper strip line.

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------------|---|---------------|-------|------|
| R _{th j-a} | thermal resistance from junction to ambient | in free air | | |
| | SOT54 | note 1 | 250 | K/W |
| | SOT23 | note 1 | 500 | K/W |
| | SOT346 | note 1 | 500 | K/W |
| | SOT323 | note 1 | 625 | K/W |
| | SOT416 | note 1 | 833 | K/W |
| | SOT883 | notes 2 and 3 | 500 | K/W |
| | SOT490 | notes 1 and 2 | 500 | K/W |

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μ m copper strip line.

PDTC114Y series

CHARACTERISTICS

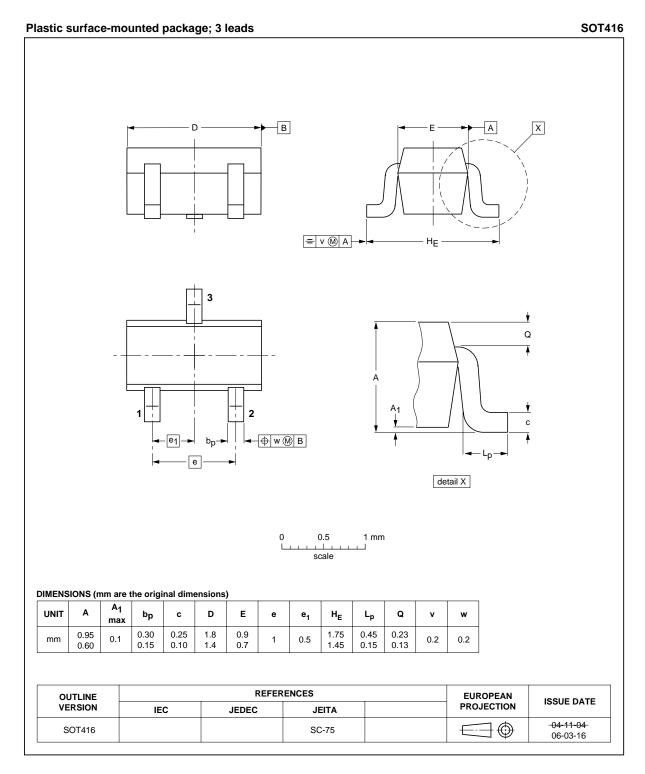
 T_{amb} = 25 °C unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------------|--------------------------------------|--|------|------|------|------|
| I _{CBO} | collector-base cut-off current | $V_{CB} = 50 \text{ V}; I_E = 0$ | - | - | 100 | nA |
| I _{CEO} | collector-emitter cut-off current | $V_{CE} = 30 \text{ V}; I_B = 0$ | - | - | 1 | μΑ |
| | | $V_{CE} = 30 \text{ V}; I_B = 0; T_j = 150 ^{\circ}\text{C}$ | - | - | 50 | μΑ |
| I _{EBO} | emitter-base cut-off current | $V_{EB} = 5 \text{ V}; I_{C} = 0$ | - | - | 150 | μΑ |
| h _{FE} | DC current gain | $V_{CE} = 5 \text{ V}; I_{C} = 5 \text{ mA}$ | 100 | - | - | |
| V _{CEsat} | collector-emitter saturation voltage | $I_{C} = 5 \text{ mA}; I_{B} = 0.25 \text{ mA}$ | - | - | 100 | mV |
| V _{i(off)} | input-off voltage | $I_{C} = 100 \ \mu A; \ V_{CE} = 5 \ V$ | - | 0.7 | 0.5 | V |
| V _{i(on)} | input-on voltage | $I_{C} = 1 \text{ mA}; V_{CE} = 0.3 \text{ V}$ | 1.4 | 0.8 | _ | V |
| R1 | input resistor | | 7 | 10 | 13 | kΩ |
| <u>R2</u> R1 | resistor ratio | | 3.7 | 4.7 | 5.7 | |
| C _c | collector capacitance | I _E = i _e = 0; V _{CB} = 10 V; f = 1 MHz | - | - | 2.5 | pF |

PDTC114Y series

NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 47 k Ω

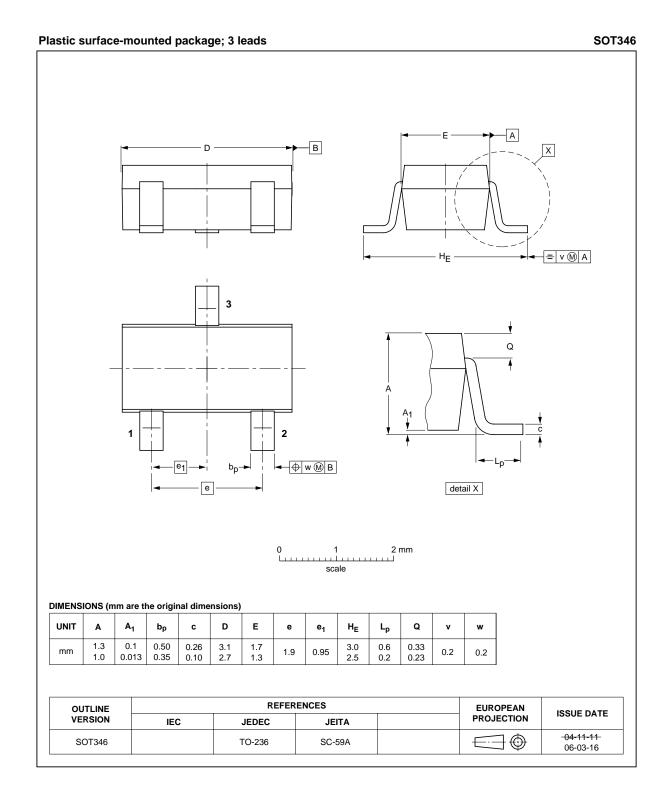
PACKAGE OUTLINES



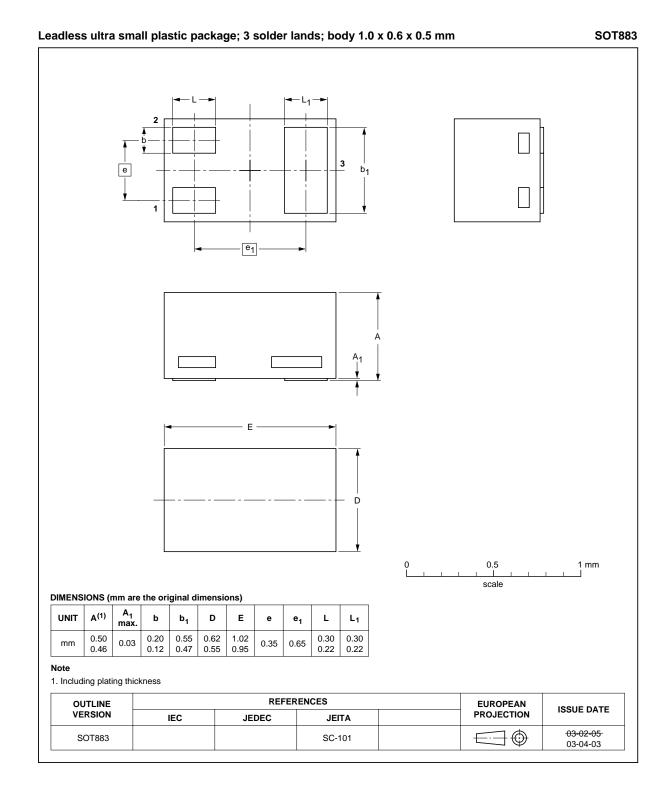
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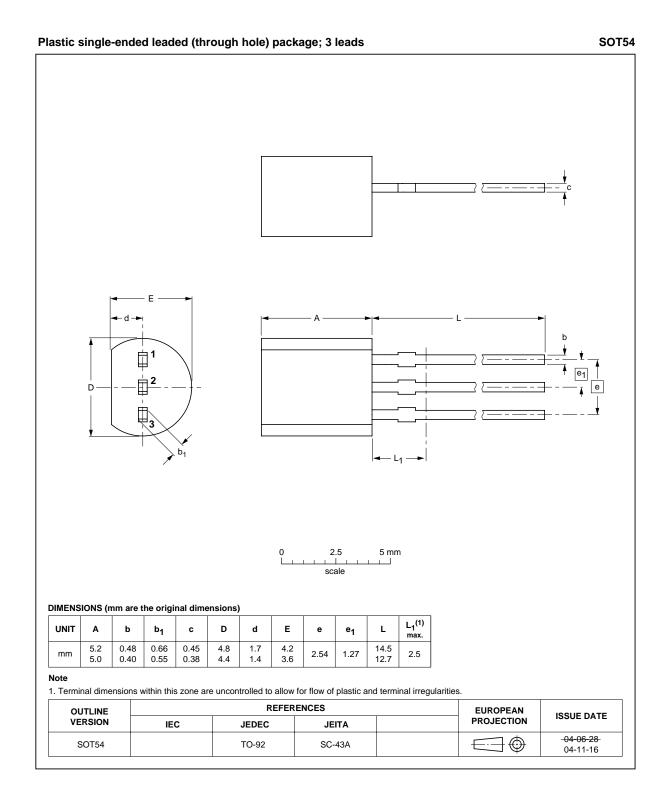
PDTC114Y series



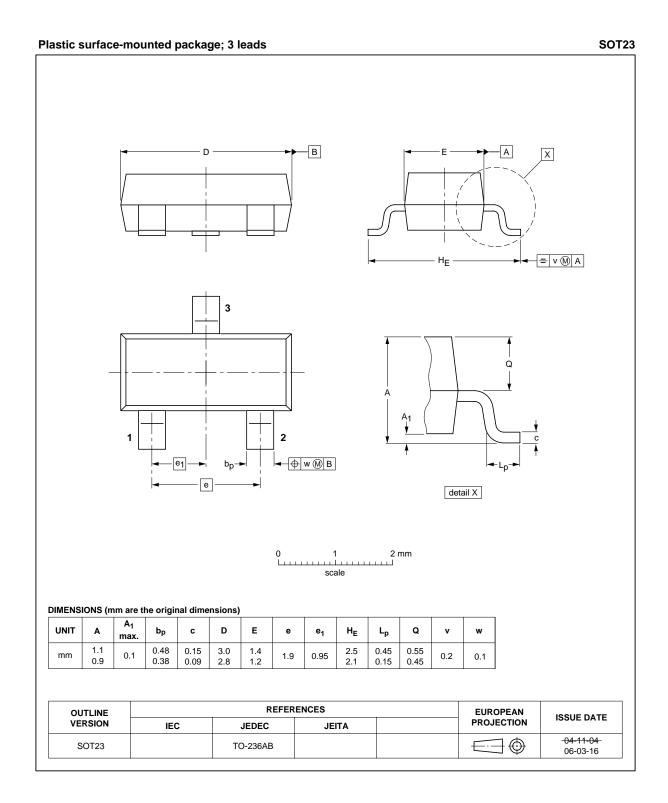
PDTC114Y series



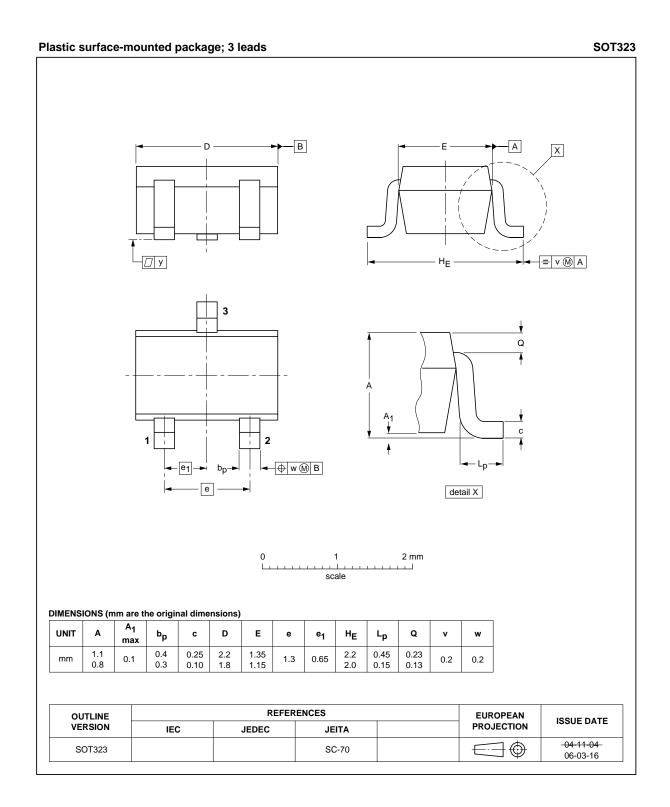
PDTC114Y series



PDTC114Y series

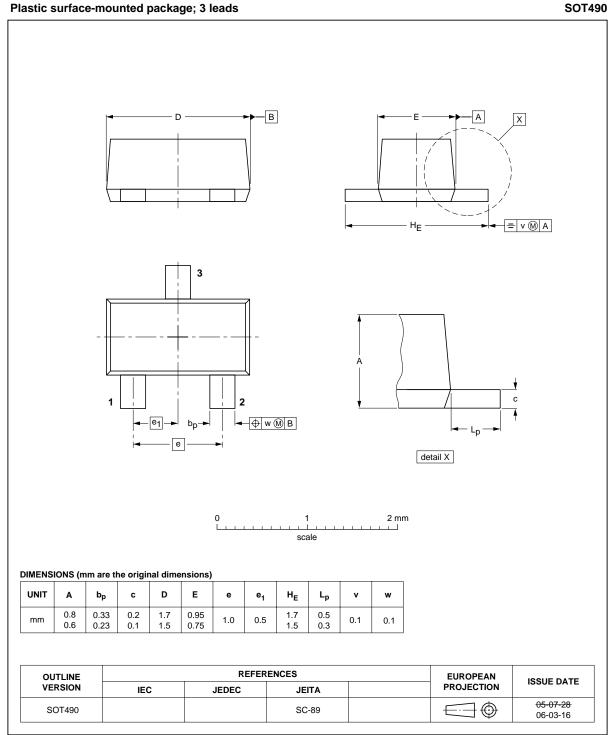


PDTC114Y series



NPN resistor-equipped transistors; $R1 = 10 \text{ k}\Omega$, $R2 = 47 \text{ k}\Omega$

PDTC114Y series



Plastic surface-mounted package; 3 leads

PDTC114Y series

DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION | |
|-----------------------------------|----------------------------------|---|--|
| Objective data sheet | Development | This document contains data from the objective specification for product development. | |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. | |
| Product data sheet | Production | This document contains the product specification. | |

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